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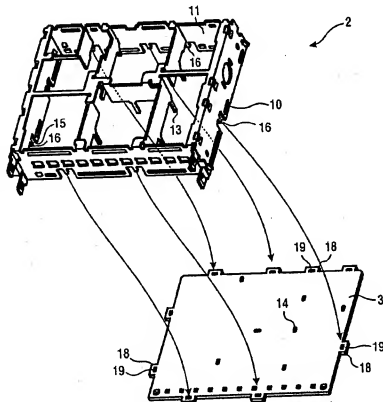
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(54) Title: **HIGH-FREQUENCY DEVICE**



(57) Abstract: A high-frequency device comprises a frame (2) provided with walls (12; 9-11) and leg sections (13; 16) extending from said walls. Said device further comprises a printed circuit board (3) extending perpendicularly to said walls, wherein said leg sections extend through holes (14; 19) in said printed circuit board and are connected to the printed circuit board by means of solder. At least one outer side wall of said frame is provided with at least one leg section which extends through a hole located in a part of said printed circuit board, which part extends through said outer side wall.

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